PRODUCT SPECIFICATION

CS0826-D-BSNTSWN-131

V1.1

June 26, 2009

Easterntronic LCD Group

REVISION RECORD

Version	Description	page	Date
V1.0 V1.1	Modify the value of Ifm from 40mA to 50mA	8	Jun 13, 2009 Jun 26,2009

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1. TYPE NUMBER AND DESCRIPTION

Type Number: CS0826-D-BSNTSWN-131

Description: 8 Characters X 2 Lines

LCD Panel: Blue STN, Negative, Transmissive

Viewing angle: 6H

Operating Temperature: $0 \, ^{0}\text{C} - 50 \, ^{0}\text{C}$

Storage Temperature: $-10^{\circ}\text{C} - 60^{\circ}\text{C}$

Backlight: Side, White LED

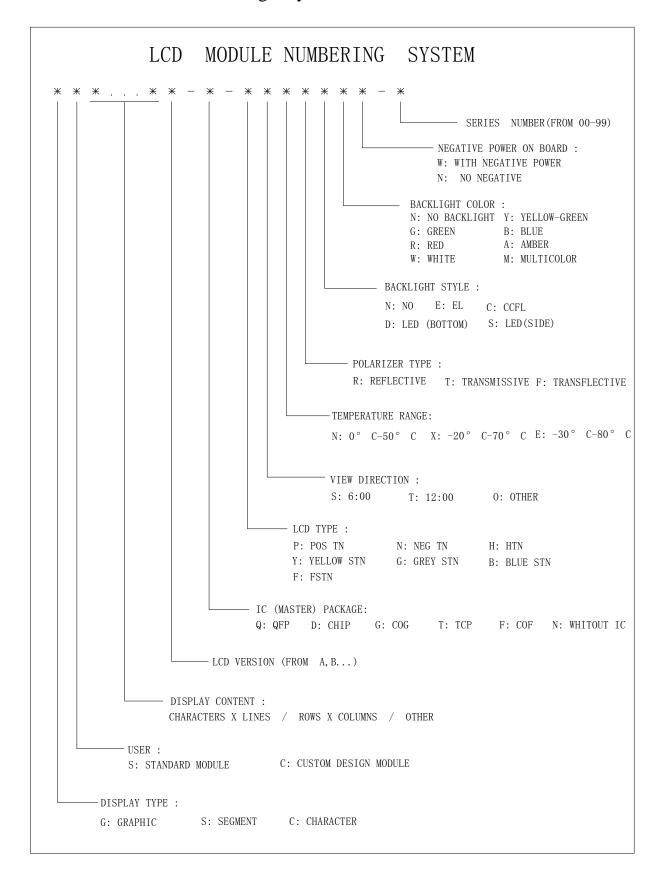
Controller: SPLC780D-001B Or Equivalent

IC Package: Bonding

Logic Voltage: 5.0V

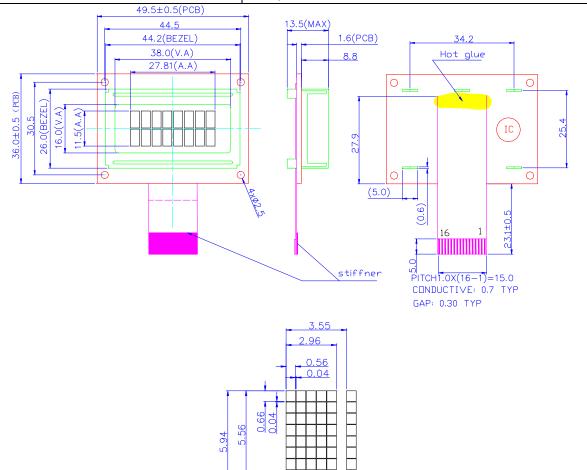
FFC: 51mm length

2. LCD Module Numbering System



3. MECHANICAL SPECIFICATIONS:

ITEM	STANDARD VALUE	UNIT
NUMBER OF CHARACTERS	8 CHARACTERS X 2 LINES	
CHARACTER FORMAT	5 X 8 DOTS	
MODULE DIMENSION	49.5(W) X 36.0(H) X 13.5(T)	mm
EFFECTTVE DISPLAY AREA	38.0(W) X 16.0(H)	mm
CHARACTER SIZE	2.96(W) X 5.56(H)	mm
CHARACTER PITCH	3.55(W) X 5.94(H)	mm
DOT SIZE	0.56(W) X 0.66(H)	mm
DOT PITCH	0.60(W) X 0.70(H)	mm
APPROX WEIGHT	TBD	g
LCD TYPE	Blue STN, Negative, Transmissive	
DUTY AND BIAS	1/8 DUTY; 1/3 BIAS	
VIEWING DIRECTION	6:00	
BACK LIGHT	Side, White LED	



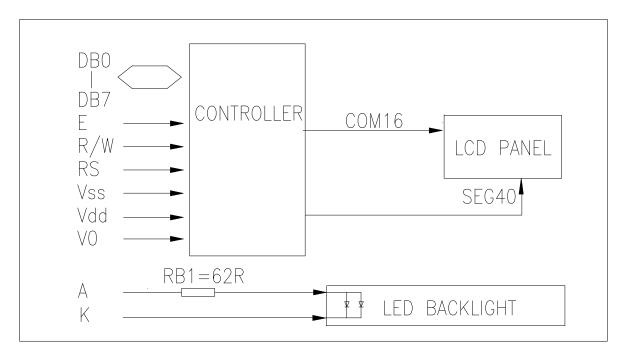
* Remark : General tolerance refers this model. (± 0.2 mm)

4. ELECTRICAL BLOCK DIAGRAM

4.1 PINS DEFINITION

PIN	SYMBOL	FUNCTION
1	Vss	Power Supply(GND)
2	Vdd	Power Supply(+5V)
3	Vo	Contrast Adjust
4	RS	Instruction/Data Register Select
5	R/W	Data Bus Line
6	Е	Enable Signal
7-14	DB0-DB7	Data Bus Line
15	A	Power Supply for Backlight+
16	K	Power Supply for Backlight-

4.2 ELECTRICAL BLOCK DIAGRAM



4.3 DISPLAY CHARACTER ADDRESS CODE

Display Position	1	2	3	4	5	6	7	8
DDD AM A Harra	00	01	02	03	04	05	06	07
DDRAM Address	40	41	42	43	44	45	46	47

5. ABSOLUTE MAXIMUM RATINGS

5.1 Electrical Maximum Ratings (Ta=25deg C)

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Supply Voltage (Logic)	Vdd – Vss	-	0	7.0	V
Supply Voltage (LCD Drive)	Vdd – V0	-	0	11.5	V
Input Voltage	Vi	-	-0.3	Vdd +0.3	V

5.2 Environmental Conditions

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Operating Temp	Topr	-	0	50	deg C
Storage Temp	Ttsg	-	-10	60	deg C

6. ELECTRICAL SPECIFICATIONS

6.1 Electrical Characteristics at Ta=25 deg C, Vdd = 5V + / - 5%

ITEM	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Supply Voltage (logic)	Vdd-Vss	-	4.5	5	5.5	V
Supply Voltage (LCD)	Vdd-V0	Vdd = 5V	4.5	4.8	5.0	V
Input signal voltage	V-ih	"H" level	2.5	-	Vdd	V
(for E, DB0-7,R/W,RS)	V-il	"L" level	-0.3	-	0.6	V
Supply Current (logic)	Icc	-	0.9	1	1.5	mA
Supply Current (LCD)	Io	-	0.15	0.22	0.27	mA
Supply Voltage (LED)	V-LED	-	2.9	3.1	3.3	V
Supply Current (LED)	If	-	-	30	50	mA
*Peak forward current(B/L)	Ifp	I mseo pulse 10% Duty Cycle	-	-	120	mA
*Power dissipation(B/L)	Pd	-	-	-	124	mW

^{*}For operation above $25\,^\circ\text{C}$, the If、Ifp &Pd must be derated, the current derating is -0.72 mA/ $^\circ\text{C}$ for DC drive and -1.72 mA/ $^\circ\text{C}$ for pulse drive,the power dissipation is -2.232 mW / $^\circ\text{C}$.The Blacklight working current must not more than 60% of the Ifmax or Ifpmax according to the working temperature.

6.2 TIMING SPECIFICATIONS at Ta = 25 deg C, Vdd = 5V + /-10%, Vss = 0V

6.2.1Write mode

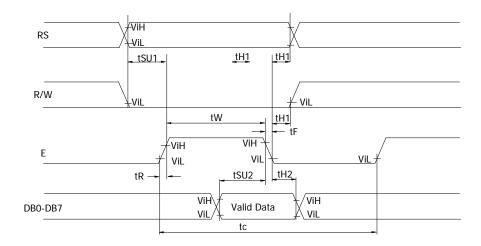
ITEM	SYMBOL	MIN	MAX	UNIT
E cycle time	tc	400	-	ns
E rise time	tR	-	25	ns
E fall time	tF	-	25	ns
E-pulse width (H, L)	tw	150	-	ns
R/W and RS set-up time	tsul	30	-	ns
R/W and RS hold time	tH1	10	-	ns
Data set-up time	tsu2	40	-	ns
Data hold time	tH2	10	-	ns

6.2.2 Read mode

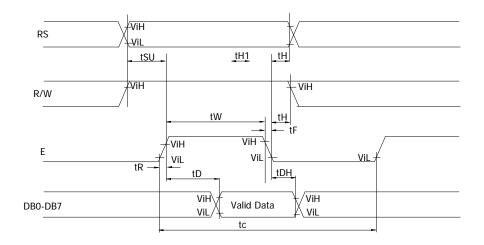
ITEM	SYMBOL	MIN	MAX	UNIT
E cycle time	tc	400	-	ns
E rise time	tR	-	25	ns
E fall time	tF	-	25	ns
E-pulse width (H, L)	tw	150	-	ns
R/W and RS set-up time	tsu	30	-	ns
R/W and RS hold time	tH	10	-	ns
Data output delay	tD	_	100	ns
Data hold time	tDH	5	-	ns

6.2.3 Timing Diagram

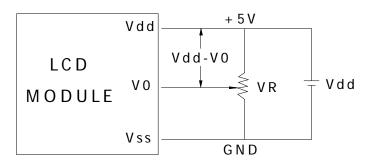
WRITE MODE TIMING DIAGRAM



READ MODE TIMING DIAGRAM



7. POWER SUPPLY FOR LCD MODULE



Vdd-V0: LCD Driving Voltage

VR: 10K - 20K

8. ELECTRO-OPTICAL CHARACTERISTIC

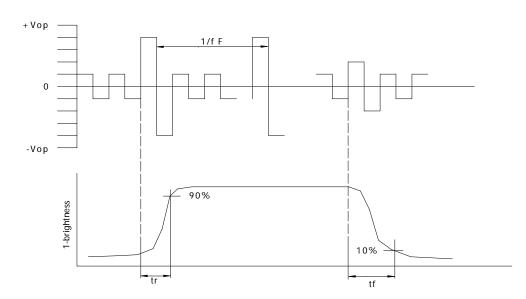
ITEM	SYMB OL	CONDI TION	MIN.	TYP.	MAX.	UNIT	REF.	
------	------------	---------------	------	------	------	------	------	--

Contrast	CR	25℃		12			Note1
Rise Time	tr	25℃		160	240	ms	Note2
Fall Time	tf	25℃		100	150	ms	note 2
Viewing Angle	θ1-θ2	25℃			60	DEG	Note 3
Viewing Angle	Ø1, Ø2	23 C	-40		40	DEO	Note 3
Frame	Ff	25℃		70		Hz	note 2
Frequency	11	25 0		, 0		112	11000 2

Note(3): Contrast ratio is defined under the following condition:

- CR= <u>brightness of selected condition</u> brightness of non-selected condition
- (a). Temperature----25C
- (b). Frame Frequency-----64Hz
- (c). Viewing angle----- θ =0, Ø=0
- (d). Operating Voltage---4.8V

Note(1): definition of response time:



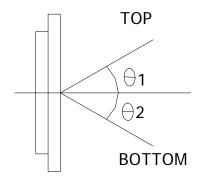
Condition:

(a). Temperature-----25C

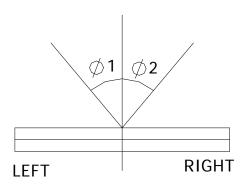
- (b). Frame Frequency-----64Hz
- (c). Viewing angle----- θ =0, Ø=0
- (d). Operating Voltage---4.8V

Note(2): definition of view angle:

TOP-BOTTOM DIRECTION



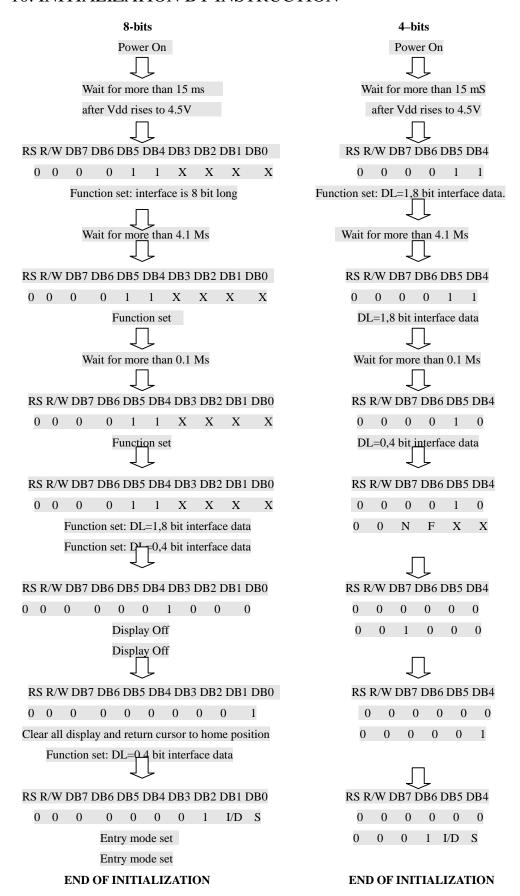
RIGHT-LEFT DIRECTION



9. INSTRUCTION TABLE

Function											Description	Execu
	S							B				Time*
		V	7	6	5	4	3	2	1	0		(Max)
Clear	0	0	0	0	0	0	0	0	0	1	Clears entire display and returns the cursor to	1.64mS
Display											home position (address 0)	
Return	0	0	0	0	0	0	0	0	1	X	±	1.64mS
Home											RAM contents remain unchanged. Set DD	
											RAM address to zero.	
Entry	0	0	0	0	0	0	0	1	1	S		40μS
mode									/		shift of the display. These operations are	
set									D		performed during data write/read of DD	
											RAM/CG RAM. 1/D=1: increment; 1/D=0:	
											decrement; S=1: whole display shift when data	
											is written.	
Display	0	0	0	0	0	0	1	D	C	В		40μS
ON/OFF											cursor(B) ON/OFF. D=1:display ON; D=0:	
control											display OFF. C=1:Cursor ON; C=0:cursot OFF.	
											B=1:Blink ON; B=0, Blink OFF.	
Cursor or	0	0	0	0	0	1	S	R	X	X	Move the cursor and shift the display without	40μS
Display							/	/			changing DDRAM contents. S/C=1: Display	
shift							C	L			Shift; S/C=0:Cursor move. R/L=1:shift to right;	
											R/L=0:shift to left.	
Function	0	0	0	0	1	D	N	F	X	X	Set interface data length (DL), number of	40μS
Set						L					display lines (N) and character font (F).DL=1:	
											8 bits; DL=0: 4 bits. N=1: 2 lines; N=0: 1 lines.	
											F=1: 5X11 dots; F=0: 5X7 dots.	
Set CG	0	0	0	1		A	4(CC	j		Set CG RAM address. CG RAM data is sent	40μS
RAM add											and received after this setting.	
Set DD	0	0	1			A	D	D			Set DD RAM address. DD RAM data is sent	40μS
RAM Add	_										and received after this setting.	
Read BF	0	1	В			P	4(7)			Read BUSY FLAG (BF) and the contents of the	0μS
& Addr			F								address counter. BF=1: internal operation;	
											BF=0: can accept instruction.	
Write	1	0			W	R	П	Έ			Write data into DD RAM or CG RAM.	40
Data to					Γ	A	T	A				μS**
RAM												-
Read Data	1	0	R	E	Α	D	Г	A	T	4	Read data from DD RAM or CG RAM.	40
from												μS^{**}
RAM	L		L									

10. INITIALIZATION BY INSTRUCTION



11. SOFTWARE EXAMPLES

8-BIT OPERATION 16 characters X 1 lines

Function	RS RW D7 D6 D5 D4 D3 D2 D1 D0	DESCRIPTION
Power on delay		Initialization. No display appears.
Function set	0 0 0 0 1 1 0 0 X X	Sets 8-bit operation, 2-line display and 5*7 dots character font.
Display OFF	0 0 0 0 0 1 0 0 0	Turn off display.
Display ON	0 0 0 0 0 1 1 1 0	Turn on display and cursor.
Entry Mode set	0 0 0 0 0 0 0 1 1 0	Set mode to increment the address by one and to shift the cursor to the right, at the time of write to the DD/CG RAM. Display is not shifted.
Write data to CG/DD RAM	1 0 0 1 0 0 1 1 1 1 0	Write "O". Cursor incremented by one and shift to right.
Write data to CG/DD RAM	1 0 0 1 0 1 0 0 1 0 <u>OR</u>	Write "R". Cursor incremented by one and shift to right
Write data to CG/DD RAM	ORIENT	Write "I" "E" "N" "T".
Set DDRAM address	0 0 1 1 0 0 0 0 0 0 O ORIENT	Set RAM address so that the cursor is positioned at the 9 th position
Write data to CG/DD RAM	ORIENT DS	Write "D" "S".
Cursor or display shift	0 0 0 0 0 1 0 0 X X <u>ORIENT DS</u>	Shift only the cursor position to the left.
Write data to CG/DD RAM	ORIENT DIS	Write "I" "S"

4-bit operation (4-bits 1 line)

Function	RS	RW	′ D7	D6	D5	D4	Display	Description	
power on delay								Initialization. No display appears.	
Frnction set	0	0	0	0	1	0		Sets to 4 -bit operation. In this case, operation is handled as 8-bits by initialization,a nd Only this instruction completes with one write.	
Frnction set	0	0	0	0	1 X	0 X		Sets 4 -bit operation, 1-line display and 5*7 dot character font. (number of display lines and character fontscannot be changed hence after.)	
Display ON/OFF Control	0	0	0	0	0	0		Turn on display and cursor.	
Entry Mode Set	0	0	0	0	0	0	_	Turn on display and cursor.	
Write data to CG/DD/ARM	1 1	0	0 1	1 1	0	0 1		Write "O". Curaor incrementer by one and shift to right.	
	same as 8-bit operation								

12. Quality units

12.1 Purpose

This standard for quality assurance should define the quality of LCD module products to customer by EASTERNTIONIC LCD GROUP.

12.2 Scope

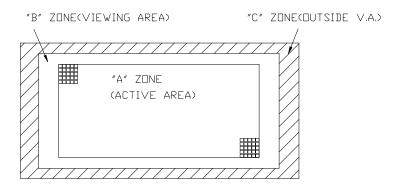
This document defines general provisions as well as inspection standards for LCD module supplied by EASTERNTIONIC LCD GROUP, except for those with special requirements from customer.

12.3 Definition

12.3.1 Definition of area

A Zone: Active area. B Zone: Viewing area

C Zone: Outside viewing area.



12.3.2 Definition of size

Large size(L): 1~6 pcs LCD screens are cut out of from each 14"×16" mother glass.

Middle size(M): 7~50 pcs LCD screens are cut out of from each 14"×16" mother glass.

Small size(S): more than 50 pcs LCD screens are cut out of from each 14"×16" mother glass.

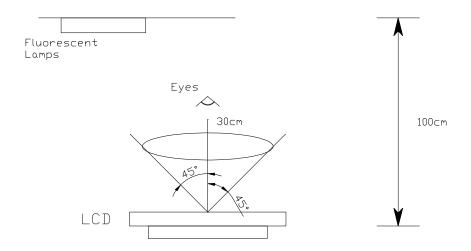
12.4 Quality Specification

12.4.1 Conditions of Cosmetic Inspection

12.4.1 Test should be conducted under the following conditions:

Ambient temperature :22 \pm 5°C. Ambient humidity: 65 \pm 20%RH Ambient Luminance: 40-watt fluorescent lamp.

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under fluorescent light. Distance between LCD and fluorescent lamps should be 100 cm or more. Viewing direction for inspection is 45° from vertical against LCD.



12.4.1.2 When test the model of transmissive product must add the reflective plate.

12.4.2 Sampling plan

Unless otherwise agreed in writing, the sampling inspection shall be applied to the incoming inspection of customer.

- Lot size: Quantity of shipment lot per model
- Sampling type: Normal inspection, single sampling
- Sampling Level: Level II
- Sampling table: GB/T2828.1.1(GB-national standard of China)

12.4.3 Classification of defects and Acceptable quality level

Defects and classified as either a major or minor defect defined as bellows:

- Major defect: It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.
- Minor defect: It is a defect that will not result in functioning problem with deviation calssifiec.

The AQL for major and minor defects is defined as follows:

Partition	Definition	AQL
Major defect	Functional defective as product	0.4
Minor defect	Satisfy all functions as product but not satisfy cosmetic standard	1.0

12.4.4 Applicable instrument

- LCD module tester
- Multimeter
- Caliper
- Defect size filming standard

12.4.5 Inspection quality criterion

12.4.5.1 LCD panel part

The inspection specification as following list:

Classify	Item	Description of defects	Inspection	on criterion	Drawing specification
Major defect	1.Non-display	Product no function	Not	accept	specification
	2.LCD with wrong view direction`	Difference in Spec.	Not	accept	
	3.Segment missing	Part or all pattern do not light up	Not	accept	
	4.Occur high current	Current exceed designed value	Not	accept	
	5. LC leakage	LC does not fulfill the glass cell	Not	accept	
	6.Deviation from drawing	LCM Dimension difference from drawing and over tolerance	_	to dimensions e specification	
	7.Wrong type applied	Wrong polarizer attachment	Not	accept	
		Pin attached wrong type applied	Not	accept	
	8.Incorrect Pin attached pins quality wrong quantity applied			accept	
Minor defect	9.Pattern deformation	Segment fatter or smaller	Dimension (mm) A≤0.1	Acceptable number Not count (Should not be connected to next dot)	

			0.10 <a≤0.15< th=""><th>1 pc / dot(only segment)or less 2 pcs / cell or less (Should not be connected to next dot)</th><th></th></a≤0.15<>	1 pc / dot(only segment)or less 2 pcs / cell or less (Should not be connected to next dot)	
			B ≤ 0.10	Not count	
Minor defect	10.Pinholes	Black spot/white spot at activated state	1m distance enlarge under 2. Middle signature (mr. $\Phi \le 0.15$ 0.15< $\Phi \le 0.25$ 0.25< $\Phi \le 0.35$ $\Phi > 0.35$ 3. Small siz Diameter (mr. $\Phi \le 0.15$ 0.15< $\Phi \le 0.25$ 0.25< $\Phi \le 0.30$ $\Phi > 0.30$ 4. For the accept is equal to lattice's 5. Only allow one segments.	an't be found at the and will not be and will not be electronic test fize LCD an) Accept QTY Not count 3 1 0 0 to LCD an) Accept QTY Not count 2 1 0 0 dot pattern: If the area of the are	$\Phi = (X+Y)/2$
	11.Blemishes and foreign matters	Black spot/dust on LCD(non-display)	distance and under electro	LCD no't find at 1m will not enlarge nic test: LCD n) Accept QTY Not count	$\Phi = (X+Y)/2$

	$0.25 < \Phi \le 0.35$
	$\Phi > 0.35$
	-Small size LCD
	Diameter(mm) Accept QTY
	$\Phi \le 0.15$ Not count
	$0.15 < \Phi \le 0.25$
	$0.25 < \Phi \le 0.30$
	$\Phi > 0.30$ 0
	2.B zone
	1.5 times of acceptable
	largest diameter size of Zone
	A
	3.C zone
	Notcount.
	Negative panel:
	1. A zone
	-Large size LCD Diameter(mm) Accept QTY
	$\Phi \le 0.15$ Not count
	_
	$0.30 < \Phi \le 0.50$
	$\Phi > 0.50$ 0
	-Middle&small size LCD
	Diameter(mm) Accept QTY
	$\Phi \le 0.15$ Not count
	0.15<Φ≤ 0.25 3
	$\Phi > 0.25$ 0
	2. B zone
	1.5 times of acceptable
	largest diameter size of Zone
	A 3.C zone
	No count
	The nearest diatance
	allowed between two black
	spot is 20mm
	Sp 0 2 20 20 20 20 20 20 20 20 20 20 20 20
l l	l l

12.Black lines and scratches surface.And foreign linear Accept if can't find at 1m	_
scratches surface.And foreign linear Accept if can't find at 1m	-
foreign linear Accept if can't find at 1m	
matters in LCD distance and will not enlarge	
under electronic test.	
ander electronic test.	
-Middle size LCD	
Diameter(mm) Accept QTY	
$W \le 0.02$ Not count	
0.02< W≤ 0.03,L ≤4 2	
0.03< W ≤ 0.05,L ≤3 2	
0.02< W≤ 0.03,L >4 0	
$0.03 < W \le 0.05, L > 3 $ 0	
W>0.05 As the spot criteria.	
W > 0.03 Fis the spot effectua.	
-Small size LCD	
Diameter(mm) Accept QTY	
$W \le 0.02$ Not count	
0.02< W≤ 0.03,L ≤4 2	
$0.02 < W \le 0.05, L \le 2$ 1	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	
W>0.05 As the spot criteria.	
W > 0.03 As the spot efficial.	
2.B zone	
1.5 times of acceptable largest	
diameter size of Zone A	
3.C zone	
Notcount.	
Negative panel:	
1. A zone	
-Large size LCD	
Diameter(mm) Accept QTY	
W≤ 0.02 Not count	
0.02< W≤ 0.03,L ≤5 3	
$0.03 < W \le 0.05, L \le 4 \qquad 2$	
0.02< W≤ 0.03,L >5 0	
$0.03 < W \le 0.05, L > 4 0$	
W>0.05 As the spot criteria.	
-Middle size LCD	
Diameter(mm) Accept QTY	
W≤ 0.02 Not count	
0.02< W≤ 0.03,L ≤4 2	
0.03< W ≤ 0.05,L ≤2 2	
0.02< W≤ 0.03,L >3 0	
$0.03 < W \le 0.05, L > 2 0$	

			W>0.05 As the spot criteriaSmall size LCD Diameter(mm) Accept QTY W≤0.02 Not count 0.02< W≤0.03,L≤3 2 0.03< W≤0.05,L≤3 1 0.02< W≤0.03,L>3 0 0.03< W≤0.05,L>2 0 W>0.05 As the spot criteria. 2. B zone 1.5 times of acceptable largest diameter size of Zone A 3.C zone Not count The nearest diatance allowed between two defects is 20mm	
Mintor defect	13. Scratch on PI coating	PI coating scratched	The visible scratch of A zone can not be accepted at 30cm view distance.	
Mintor defect	14. Rainbow	Arches, circular or parallel colorful spread	According to the limit specimen	
Mintor defect	15. Bubbles or wrinkles in polarizer	Bubbles or wrinkles between polarizer and glass	A zone:The visible defect can not be accepted at 30cm view distance. B zone: Not count	
Mintor defect	16. Position of polarzer attachment	Wrong polarizer attachment in position or dimension	Polarizer protruding from edge of glass and exceeding/within the maximum external dimension of LCD	
Mintor defect	17. Ink printing defect	17.1 Ink line/pattern broken	Not accept	

		17.2 Ink pattern/line jagged 17.3 Light leakage 17.4 Ink printing pattern/line uneven	less than width, o specimen When white lig of pinho printing to the pin Reject if than 1/2V	activated ht appear le or scra misalign hole spec the thick	with with s in the atch dument. Accification or thin	current position e to ink ecording n. in more	
Mintor defect	18. Pin defect	18.1 Corrosion or foreign material on terminal legs 18.2 Pin deviation over tolerance	plating on bott legs.Not	ng to the s	ncludin),excess s or pecifica	epoxy terminal	•
Mintor defect	19. Chipped glass on comer	19.1 Chip in lead contact area.	a≤5mm L>5m m a <l L<5m m</l 	b b≤W b≤W	c c≤T c≤T	accept QTY 3	ITO W
		19.2 Others	Not exc width of	ceed 1/2 seal	c≤T	3	lo control of the con
Mintor defect	20. Glass	chip on edge	a a≤5mm	Not exceed 1/2 width of seal	c c≤T	accept QTY 3	

Mintor	21. Clipped electrode pad	21.1Glass chip on ITO edge	a	b	С	accept QTY	ITO
defect		,	a≤4mm (and not exceed 4 ITO termina 1	b≤W/4	c≤T	3	
		21.2 Glass chip on ITO back	a	b	c	accept QTY	
			a≤5mm	b≤W/3	c≤T	3	W No see the second sec
Mintor defect	22. Mechanical	Extended crack inspector shall	b		accept	QTY	
	damage	attempt to remove the chip with tweezers,re-eval uate if the remaining defect is still a crack or a chip	b≤W/4 2				
Mintor defect	23.Gla	ss cracks	Not acce	pt	I		

Remark:

The minimum space between any 2 defects(spot,dirt) should more than 20mm, and max. allowed defect QTY in total:

Large size LCD: Zone $A \le 5/\text{unit}$, Zone $B \le 5/\text{unit}$; Middle size LCD: Zone $A \le 3/\text{unit}$, Zone $B \le 3/\text{unit}$;

Small size LCD: Zone $A \le 2/unit$, Zone $B \le 2/unit$;

12.4.5.2 Other part

The inspection specification as following list:

NO.	Items	Criterion of defects	AQL
1	Backlight	 Lumination source flickers. Using spot, lines and contamination standard of LCD to judge the spots or scratches defect on backlight. 	Major Minor
		3. Not allow unlighted on backlight.	Major
		4. Colour and luminance of backlight should correspond its specification.	Major
2	PCB,COB	1.COB seal may not have pinholes larger than 0.2mm or contamination.	Minor
		2.COB seal surface may not have pinholes through to the IC.	Minor
		3. The height of COB should not exceed the height indicated in the assembly diagram.	Major
		4. Beyond 2mm of the seal area, there may not have sealant on the PCB.	Minor
		5.No oxidation or contamination on PCB connector.	Minor
		6.Parts on PCB should correspond the characteristic, and not	Major
		allow wrong parts,missing parts or additional parts. 7.The jumper on the PCB should correspond to the characteristic.	Minor
		8. The solder which gets on bezel, LED pad, zebra pad or screw hole pad should be smoothed down.	Major
		1. No unmelted solder pastes on the PCB.	Minor
3	Soldering	2. No cold solder joints, solder connection missing, oxidation of solder.	Minor
		3. No short circuits in components on PCB.	Minor
4	General Appearance	1. No oxidation, contamination, curves, cracks or bends on interface Pin of TCP.	Minor
	11	2. No solder residue or solder balls on product.	Minor
		3. The IC on TCP may not be damaged.	Major
		4. The residual rosin or tin oil of soldering(component or chip component) is not turned into brown or black colour.	Minor
		5. Packing method correspond the specification.	Major
		6. Dimension and structure correspond the specification sheet.	Major
		7. No dirt and break on the heat seal.	Major

12.5 Reliability

The LCD module shall not fail the following reliability test.

Item	Condition	Criterion		
High temperature operation	$+50^{\circ}\text{C} \pm 2^{\circ}\text{C}$, 8 hours			
Low temperature	$0^{\circ}C \pm 2^{\circ}C$, 8 hours	1.Total current		
operation		consumption		
Humidity	Operation	$40 \degree C \pm 2 \degree C$, 93% $\pm 2\%$ RH,8 hours	should be below double of initial	
	Storage	$40 \degree C \pm 2 \degree C$, 93% $\pm 2\%$ RH,	value. 2.Cosmetic defects	
		24 hours	should not be	
High temperature storage	+60°C±2°C, 10 h	happened		
Low temperature	$-10^{\circ}\text{C} \pm 2^{\circ}\text{C}$, 10 he			
storage				
Thermal shock	0°C∼+50°C			
storage	60min~60min, 5 cy			
Vibration test	Amplitude: 0.7~1.0			
Shock test	in each direction(X			
Shock test	To be measured aft 80cm high on the c			
	state.(weight \geq 15K			
	Weight < 15Kg, dro			
	weight ~13Kg,uio			
	B A B,C,D edge: once Governer Surface Dropping method corner dropping A corner: once Edge dropping B,C,D edge: once Face dropping E,F,G face: once			

Remark: The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.

13. STANDARD CHARACTER PATTERN

Upper 4bit Lower	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LННН	HLLL	HLLH	HLHL	нгнн	HHLL	ннгн	нннг	ннн
4bit LLLL	CG RAM (1)															
LLLH	(2)															
LLHL	(3)															
LLHH	(4)															
LHLL	(5)															
LHLH	(6)															
LHHL	(7)															
ІННН	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
нгнн	(4)															
HHLL	(5)															
ннгн	(6)															
нннг	(7)															
нннн	(8)															

14. PRECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handing,

- (1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degredation, polarizer peel off or bubble.
- (2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface. Wipe gently with cotton. Chamois or other soft material soaked in petroleum benzin.
- (3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.
- (4). Glass can be easily chipped or cracked from rough handing. especially at corners and edges.
- (5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

- (1). Do not tamper in any way with the tabs on the tabs on the metal frame.
- (2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattem.
- (3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).
- (4). When mounting a LCM make sure that the PCB is not under any tress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- (5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing piels.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

- (1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- (2). The modules should be kept in antistatic bags or other containers resistant to static for storage.

- (3). Only properly grounded soldering irons should be used.
- (4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.
- (5). The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.
- (6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.
- 2.3. Soldering
- (1). Solder only to the I/O terminals.
- (2). Use only soldering irons with proper grounding and no leakage.
- (3). Soldering temperature: 280 $^{\circ}\text{C} \pm 10^{\circ}\text{C}$
- (4). Soldering time: 3 to 4 sec.
- (5). Use eutectic solder with resin flux fill.
- (6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4. Operation

- (1). The viewing angle can be adjusted by varying the LCD driving voltage V0.
- (2). Driving voltage should be kept within specified range; excess voltage shortens display life.
- (3). Response time increases with decrease in temperature.
- (4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
- (5). Mechanical disturbance during operation (such as pressing on the viewing area) nay cause the segments to appear "fractured".

2.5. Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

2.6. Limited Warranty

Unless otherwise agreed between EASTERNTRONIC and customer, EASTERNTRONIC will replace or repair any of its LCD and LC, which is found to be defective electrically and visually when inspected in accordance with EASTERNTRONIC acceptance standards, for a period on one year fron data of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of EASTERNTRONIC is limited to repair and/or replacement on the terms set forth above. EASTERNTRONIC will not responsible for any subsequent or consequential events.

15. Declaration of conformity regarding the limitation of dangerous substances

深圳易事通液晶显示模块有限公司

SHENZHEN EASTERNTRONIC LCM CO., LTD.

4F, B3 Building, FuYuan Industrial Zone, FuYong Town,

BaoAn District, ShenZhen, P.R. China

DECLARATION OF CONFORMITY REGARDING THE LIMITATION OF DANGEROUS SUBSTANCES

WE, SHENZHEN EASTERNTRONIC LCM CO., LTD,

Declare that the product of CSO826-D-BSNTSWN-131 complies with: The directive 2002/95/EC Dated 2003/01/27 regarding the limitation of dangerous substances, in particular to clause 4 which forbids the use of the following elements:

- Lead
- Mercury
- Cadmium
- Hexavalant chromium
- •Polybrominated biphenyls
- Polybrominated diphenylethers

And to the annex which points out the exempted implementations \square To the directive 73/23/eec dated 1973/02/19 and the standard EN60335-1 regarding prohibition of following elements:

- Oils containing polychlorinated biphenyl
- Asbestos
- Radioactive substances

Name: Ding

SHENZHEN EASTERNTRONIC LCM CO., LTD.

Issued on June 13, 2009

According with the proposal of Technical Adaption Committee (TAC) of a limit of 0.1% by weight for lead hexavalent chromium, mercury, PBBs and PBDRs and 0.01% by weight for Cadmium.